



# DATA SHEET

# CURRENT SENSOR - LOW TCR AUTOMOTIVE GRADE

PA\_E series 5%, 1%, 0.5% sizes 2512

RoHS compliant & Halogen free



# YAGEO Phícomp

Chip Resistor Surface Mount PA\_E

SERIES 2512

# <u>SCOPE</u>

This specification describes PA series current sensor - low TCR with lead-free terminations made by metal substrate.

### APPLICATIONS

# Consumer goods

- Computer
- Telecom / Datacom
- Industrial / Power supply
- Alternative Energy
- Car electronics

# FEATURES

- AEC-Q200 qualified
- Halogen-free Epoxy
- RoHS compliant
- Reduce environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/production
- Low resistances applied to current sensing
- Anti-sulfur

# ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

# **GLOBAL PART NUMBER**

# PA <u>XXXX X X X XX XXXX E</u>

	(1)	(2)	(3)	(4)	(5)	(6)	(7)
(I) SIZE							
2512							
(2) TOLERA	ANCE						
D= ± 0.5	5%						
$F = \pm 1\%$							
$J = \pm 5\%$							
(3) PACKA	GING T	YPE					
K = Emb	ossed taj	oing r	eel				
(4) TEMPER	ATURE	co	EFFI	CIE	NT O	F RESIS	TANCE
$F = \pm 10$	0 ppm/°	С					
$M = \pm 75$	5ppm/°C	-					
$E = \pm 50$	ppm/°C						
(5) TAPINO	REEL						
07 - 7 .						(1) • 0	

07 = 7 inch dia. Reel & standard power (1W)

7W = 7 inch dia. Reel & 2 x standard power (2W)

7T = 7 inch dia. Reel & 3 x standard power (3W)

# (6) RESISTANCE VALUE

0.5 m $\Omega$  to 100 m $\Omega$ 

# (7) DEFAULT CODE

Letter E is the system default code for ordering only. <sup>(Note)</sup>

Resistance rule of global part number							
Resistance code rule	Example						
XUXX	$0U5 = 0.5 \text{m}\Omega$						
ORXXX	$0R001 = 1 m\Omega$						
(I to I00 mΩ)	$0R05 = 50 \text{ m}\Omega$						

# **ORDERING EXAMPLE**

The ordering code of a PA2512 1W chip resistor, TC100, value  $0.003\Omega$  with  $\pm 1\%$  tolerance, supplied in 7-inch tape reel is: PA2512FKF070R003E

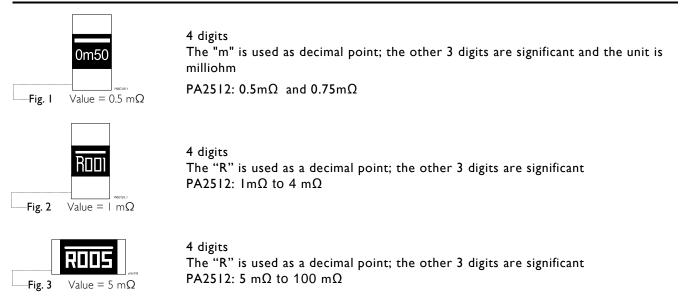
### NOTE

I. All our RChip products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead-Free Process"

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# MARKING

#### PA2512



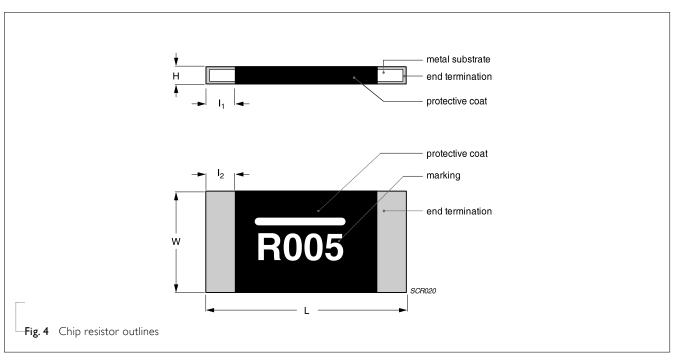
# **CONSTRUCTION**

The resistors are constructed using outstanding TCR level material, which makes Yageo PA resistors excellent for current sensing application in battery charger circuit & DC-DC converter.

The composition of the resistive material is adjusted to give the approximate required resistance and is covered with a protective coating. Marking is printed on the top side of the resistor.

Finally, the three external terminations (Cu / Ni / matte Tin) are added, as shown in Fig. 4.

#### Outlines



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# **DIMENSION**

Table I For outlines, please refer to Fig. 4

TYPE	RESISTANCE RANGE	L (mm)	W (mm)	H (mm)	I⊤(mm)	l <sub>2</sub> (mm)
	$0.5m\Omega \le R \le 0.75m\Omega$	6.35±0.25	3.18±0.25	0.63±0.25	2.72±0.25	2.72±0.25
PA2512	$Im\Omega \le R \le 4m\Omega$	6.35±0.25	3.18±0.25	0.63±0.25	2.21±0.25	2.21±0.25
	$5m\Omega \le R \le 6m\Omega$	6.35±0.25	3.18±0.25	0.63±0.25	1.19±0.25	1.19±0.25
	$7m\Omega \le R \le 100m\Omega$	6.35±0.25	3.18±0.25	0.63±0.25	0.76±0.25	0.76±0.25

Note:

1. For relevant physical dimensions, please refer to construction outlines.

2. Please contact with sales offices, distributors and representatives in your region before ordering.

# ELECTRICAL CHARACTERISTICS

Table 2

TYPE	SIZE	POWER RATING	TOLERANCE	RESISTANCE RANGE	TEMPERATURE COEFFICIENT OF RESISTANCE
		IW	±0.5%		±50ppm/°C
PA	PA 2512	2W	±1%	$0.5 \text{m}\Omega \leq \text{R} \leq 100 \text{m}\Omega$	±75ppm/°C
		3W	±5%		±100ppm/°C

Note: Please contact with sales offices, distributors and representatives in your region before ordering.

# FUNCTIONAL DESCRIPTION

**OPERATING TEMPERATURE RANGE** 

PA2512 Range: -55°C to +170°C

### **POWER RATING**

Standard rated power at 70°C:

For detail power value, please refer to Table 2.

# **RATED VOLTAGE**

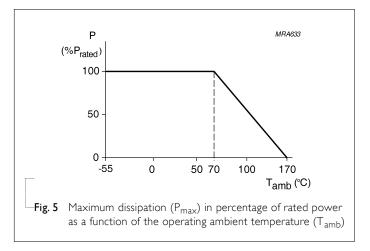
The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

 $V = \sqrt{(PxR)}$ Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

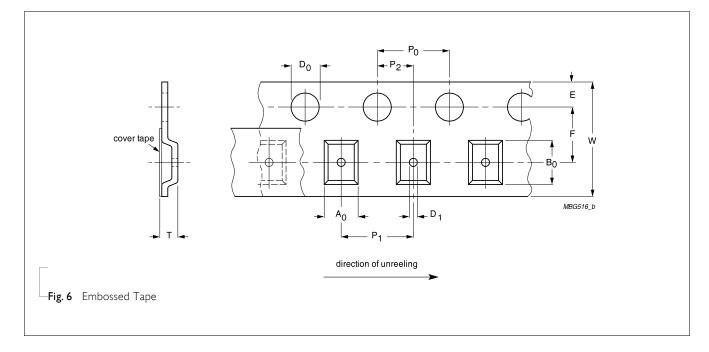
 $R = Resistance value (\Omega)$ 



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	STYLE AND PACKAGING QUANT Packing style and packaging quantity	<u> 1174</u>			

PACKING STYLE	REEL DIMENSION	PA2512
Embossed taping reel (K)	7" (178 mm)	4,000

# EMBOSSED TAPE

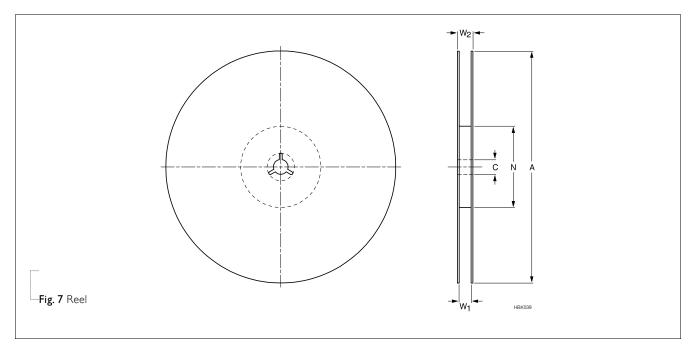


# \_\_\_\_\_Table 4 Dimensions of embossed tape for relevant chip resistors size

SIZE	SYMBOL										Unit: mm
	A <sub>0</sub>	B <sub>0</sub>	W	Е	F	Po	Pı	$P_2$	$OD_0$	ØD	т
PA2512	<b>2</b> 3.40±0.15	6.70±0.15	12.00±0.30	1.75±0.10	5.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.55±0.05	1.50±0.10	0.80±0.15

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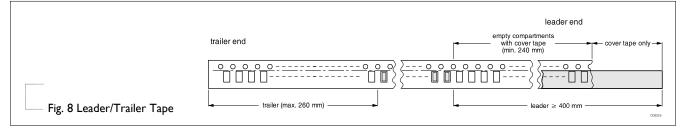
# **REEL SPECIFICATION**



# - Table 5 Dimensions of reel specification for relevant chip resistors size

	QUANTITY -	REEI	SIZE	SYMBOL					Unit: mm
SIZE	PER REEL	8 mm TAPE WIDE	I 2 mm TAPE WIDE	А	Ν	С	D	Wı	W <sub>2 MAX.</sub>
PA2512	4000		7" (Ø178 mm)	178.0±1.0	60.0+1/-0	13.50±0.5	21.0±0.8	3.6±0.5	16.5±0.5

# LEADER/TRAILER TAPE SPECIFICATION

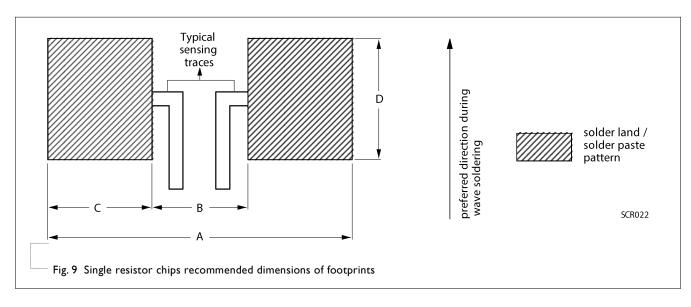


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# FOOTPRINT AND SOLDERING PROFILES

For recommended soldering profiles, please refer to data sheet "Chip resistors mounting".

### FOOTPRINT



# Table 6 Footprint dimensions

	RESISTANCE				Unit: mm	
SIZE	RANGE	А	В	С	D	
PA2512	$0.5m\Omega \le R < Im\Omega$	7.36	0.50	3.43	3.68	
	$Im\Omega \le R \le 4m\Omega$	7.37	1.27	3.05	3.68	
	$5m\Omega \le R \le 6m\Omega$	7.40	3.18	2.11	3.68	
	$7m\Omega \le R \le 100m\Omega$	7.36	4.06	1.65	3.68	

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# TESTS AND REQUIREMENTS

# Table 8 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENT	
Short time overload	IEC60115-14.13	5 times of rated power for 5 seconds at room temperature	±(0.5%+0.0005 <b>Ω</b> ) No visible damage	
High Temperature Exposure	MIL-STD-202-Method 108	I,000 hours at maximum operating temperature depending on specification, unpowered	±(1.0%+0.0005 <b>Ω</b> )	
		No direct impingement of forced air to the parts Tolerances: 170±3°C		
Temperature Cycling			±(0.5%+0.0005 <b>Ω</b> )	
Moisture Resistance	MIL-STD-202-Method 106	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25°C / 65°C 95% R.H, without steps 7a & 7b, unpowered	±(0.5%+0.0005 <b>Ω</b> )	
Biased	MIL-STD-202 Method 103	l,000 hours; 85°C / 85% RH	±(0.5%+0.0005 <b>Ω</b> )	
Humidity		10% of operating power		
Operational Life/ Endurance	MIL-STD-202-Method 108	1,000 hours at 125±3°C, de-rated voltage applied for 1.5 hours on, 0.5 hour off, still- air required	±(1.0%+0.0005 <b>Ω</b> )	
		1,000 hours at 70±2°C applied RCWV	$\pm$ (1.0%+0.0005 $\Omega$ )	
		1.5 hours on, 0.5 hour off, still air required		
Resistance to Solvents	MIL-STD-202 Method 215	Immerse in isopropyl alcohol for 5 min with ultrasonic at room temperature	No Visible damage	
Mechanical Shock	MIL-STD-202 Method 213	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen.	±(0.5%+0.0005 <b>Ω</b> )	
		Peak value: 100 g's		
		Duration: 6 ms		
		Velocity change: 12.3 ft/s		
		Waveform: Half sine		
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations	±(0.5%+0.0005 <b>Ω</b> )	
		Test from 10-2000 Hz.		
Resistance to	MIL-STD-202-method 210	Condition B, no pre-heat of samples	$\pm (0.5\% + 0.0005 \Omega)$	
Soldering Heat		Leadfree solder, 260°C, 10 seconds immersion time	No visible damage	
		Procedure 2 for SMD: devices fluxed and cleaned with isopropanol		
Thermal Shock	MIL-STD-202 Method 107	-55/+125°C, Number of cycles is 300.	$\pm (0.5\% + 0.0005 \Omega)$	
		Devices mounted.	No visible damage	
		Maximum transfer time is 20 seconds.		
		Dwell time is 15 minutes. Air -Air		

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TEST	TEST METHOD	PROCEDURE	REQUIREMENT	
Electrostatic	AEC-Q200-002	Human Body Model, I pos + I neg.	±(1.0%+0.0005 <b>Ω</b> )	
Discharge		Discharges 2512=2KV	No visible damage	
Solderability - Wetting	J-STD-002B test B	(a) Method B, aging 4 hours at 155°C dry heat, dipping at 235±3°C for 5±0.5 seconds.	Well tinned (>95% covered) No visible damage	
		(b) Method B, steam aging 8 hours, dipping at 215±3℃ for 5±0.5 seconds.		
		(c) Method D, steam aging 8 hours, dipping at 260±3 °C for 7±0.5 seconds.		
Flammability	Flammability UL94 Try to inflame a specimen by a needle flame		No ignition of specimen; V-0	
Board Flex / Bending	AEC-Q200-005	Chips mounted on a 90mm glass epoxy resin PCB (FR4), Bending for 2512=2 mm	±(1.0%+0.0005 <b>Ω</b> )	
		Holding time: Min.60 seconds		
Terminal Strength (SMD)	AEC-Q200-006	Applied a 17.7N (1.8Kg) for 60±1 seconds.	$\pm$ (1.0%+0.0005 $\Omega$ ) No visible damage	
Flame Retardance	AEC-Q200-001	Apply voltage from 9V to 32V to increase the surface temp to 350°C	No flame, no explosion	
Temperature	MIL-STD-202 Method 304	At +25/+150°C	Refer to table 2	
Coefficient of		Formula:		
Resistance (T.C.R.)		T.C.R= $\frac{\mathbf{R}_2 - \mathbf{R}_1}{\mathbf{RI}(\mathbf{t}_2 - \mathbf{t}_i)} \times 10^6 (\text{ppm/°C})$		
		Where		
		tl=+25°C or specified room temperature		
		t2=+150°C test temperature		
		RI=resistance at reference temperature in ohms		
		R2=resistance at test temperature in ohms		
Flower-of-Sulfur (FOS)	Modified ASTM B809-95	Sulfur 105°C, 750 hours, unpowered.	±(1.0%+0.0005 <b>Ω</b> )	

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# <u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 10	Jan. 31, 2018	-	- Extend 0.5% Tolerance
Version 9	Nov. 21, 2017		- Extend resistor value for 3W
Version 8	Oct. 23, 2017	-	- Update footprint dimensions
Version 7	Jul. 24, 2017	-	- Add part number coding details for the relationship between taping reel and rated power
Version 6	Apr. 19, 2017	-	- Extend resistor value
Version 5	Nov. 30, 2016	-	- Extend resistor value
Version 4	Oct. 27, 2016	-	- Modify the error of test procedure
Version 3	Mar. 31, 2016	-	- Update TCR
Version 2	Dec. 31, 2015	-	- Extend resistor value
Version 1	Dec. 18, 2015	-	- Update tests and requirements

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PA2512JKF7W0R005E PA2512JKF7W0R001E PA2512JKF7W0R003E PA2512JKF7W0R002E PA2512JKF7W0R004E PA2512JKF7T0R004E PA2512JKF070R003E PA2512JKF7T0R002E PA2512JKF7T0R005E PA2512JKF070R004E PA2512JKF7T0R001E PA2512JKF7T0R003E PA2512FKF7T0R005E PA2512JKF070R002E PA2512FKF7T0R002E PA2512FKF7T0R003E PA2512FKF7T0R004E PA2512FKF7T0R005E PA2512JKF070R002E PA2512JKF070R001E PA2512JKF070R005E PA2512FKF7W0R006E PA2512FKF7W0R01E PA2512FKF7W0R05E PA2512FKF7T0R01E PA2512FKF7W0R005E PA2512FKF7T0U5E PA2512FKE7W0R01E PA2512FKF7W0R001E PA2512FKF7T0R01E PA2512FKE7W0R005E PA2512FKF7T0U5E PA2512FKE7W0R01E PA2512FKM7W0R001E PA2512FKE7T0R015E PA2512FKE7W0R005E PA2512FKM7W0R02E PA2512FKM070R01E PA2512FKE7T0R015E PA2512FKE7W0R007E PA2512FKM7W0R02E PA2512FKM070R01E PA2512FKE7T0R015E PA2512FKE7W0R007E PA2512FKM7W0R02E PA2512FKM070R01E PA2512FKE7T0R015E PA2512FKE7W0R007E PA2512FKM7W0R02E